

**RESPONSE UNDER 37 C.F.R. § 1.116**

**EXPEDITED PROCEDURE – Art Unit 2814**

Attorney Docket No. 108298742US

Disclosure No. 03-0599.00/US

**Amendments to the Specification:**

Please replace paragraph [0001] with the following:

This application is related to U.S. Patent Application No. 10/733,226\_\_\_\_\_  
(~~Attorney Docket No. 108298744US; Micron Disclosure No. 03-0477~~) entitled  
MICROELECTRONIC DEVICES AND METHODS FOR FILLING VIAS IN  
MICROELECTRONIC DEVICES, filed concurrently herewith and incorporated herein in  
its entirety by reference.